■ Features

- High Output Power: P_{sat}=51.0dBm (Typ.)
- High Gain: G_p=10.0dB (Typ.)
- High Power Added Efficiency: PAE=40% (Typ.)
- Broad Band: 8.5 to 9.8GHz
- Impedance Matched Zin/Zout = 50ohm
- Hermetically Sealed Package

■ Description

The SGC8598-100A-R is a high power GaN-HEMT that is internally matched for X-band radar bands to provide optimum power and gain in a 50ohm system.

ABSOLUTE MAXIMUM RATING (Case Temperature T_c=25 deg.C)

Item	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	55	V
Gate-Source Voltage	V_{GS}	-15	V
Storage Temperature	T_{stg}	-55 to +125	deg.C
Channel Temperature	T_{ch}	+250	deg.C

RECOMMENDED OPERATING CONDITION

Item	Symbol	Condition	Limit	Unit
Drain-Source Voltage	V_{DS}		<=50	V
Forward Gate Current	I_{GF}	Rg=100ohm	<=6.0	mA
Reverse Gate Current	I_{GR}	Rg=100ohm	>=-4.5	mA
Channel Temperature	T_{ch}		<+200	deg.C

ELECTRICAL CHARACTERISTICS (Case Temperature T_c=25 deg.C)

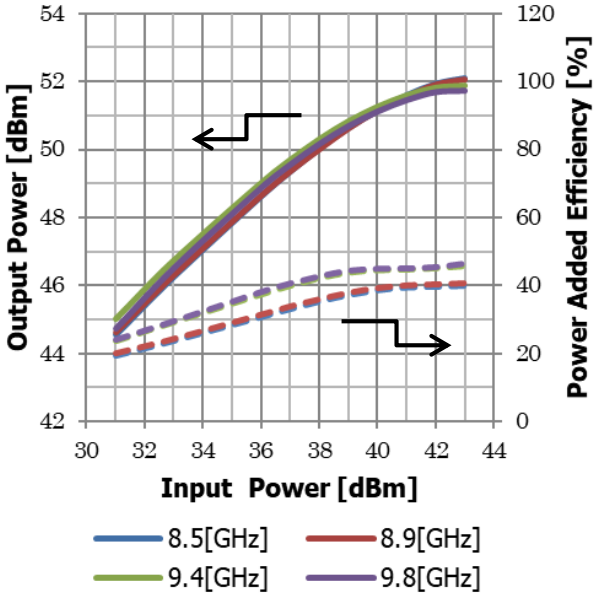
Item	Symbol	Condition	Limit			Unit
			Min.	Typ.	Max.	
Pinch-off Voltage	V_P	V_{DS}=50V, I_{DS}=6.5mA	-	-4.5	-	V
Frequency Range	Freq.	V_{DS}=50V-typ. $I_{DS(DC)}$=0.33A-typ. Pulse Width=100µsec. Duty=10%	8.5	-	9.8	GHz
Output Power at Pin=41dBm	P_{sat}		50.0	51.0	-	dBm
Power Gain at Pout=50dBm	G_P		9.0	10.0	-	dB
Drain Current at Pin=41dBm	I_{DSR}		-	5.7	7.4	A
Power Added Efficiency at Pin=41dBm	PAE		-	40	-	%
Gain Flatness	ΔG		-	1.6	-	dB
Thermal Resistance	R_{th}	Channel to Case (P_{diss}=100W, CW)	-	1.4	1.8	deg.C/W

CASE STYLE	IK	
RoHS Compliance	YES	
ESD	Class 2	2000V to <4000V

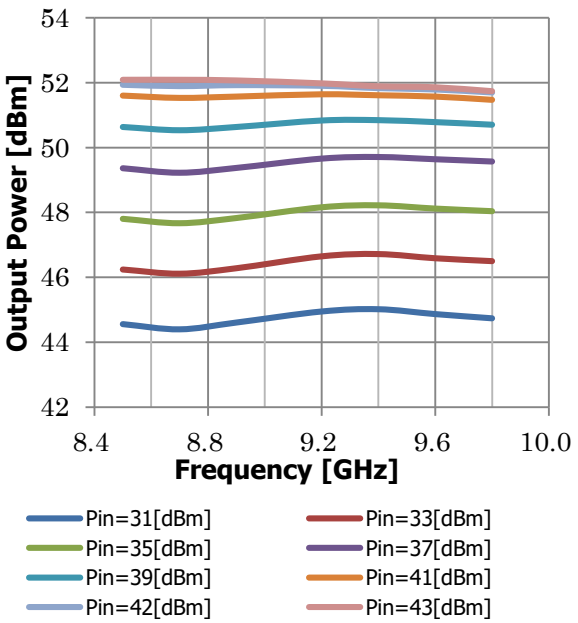
Note: Based on ANSI/ESDA/JEDEC JS-001-2012(C=100pF, R=1.5kohm)

● RF Characteristics

Output Power & Power Added Efficiency vs. Input Power
V_{DS}=50V, $I_{DS(DC)}$=0.33A
PW=100µsec., Duty=10%

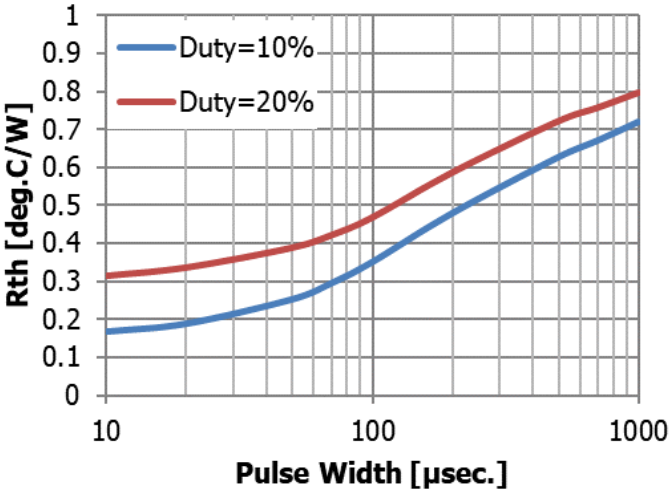


Output Power vs. Frequency
V_{DS}=50V, $I_{DS(DC)}$=0.33A
PW=100µsec., Duty=10%

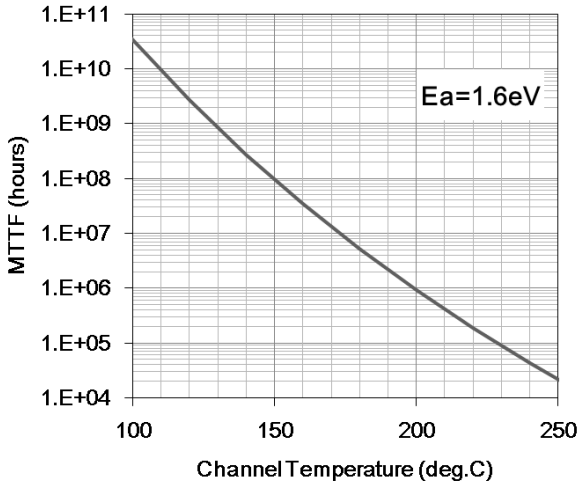


● Thermal Characteristics In Pulsed Operation

Rth vs. Pulse Width
Tc=75deg.C

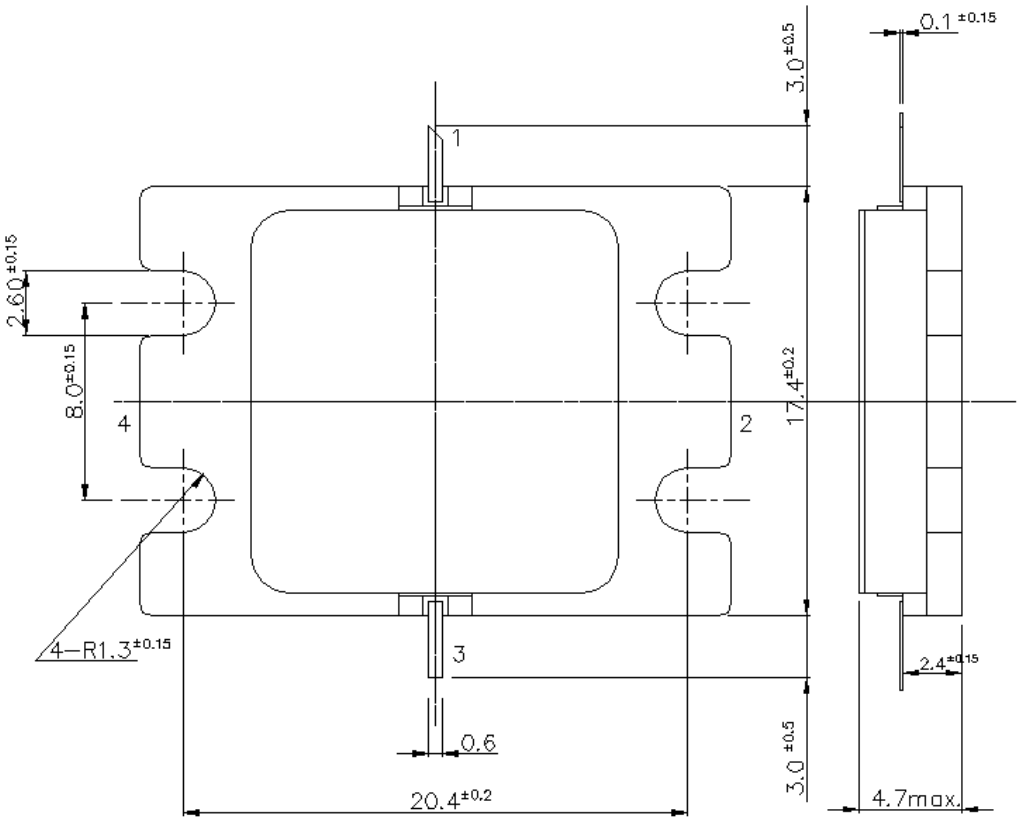


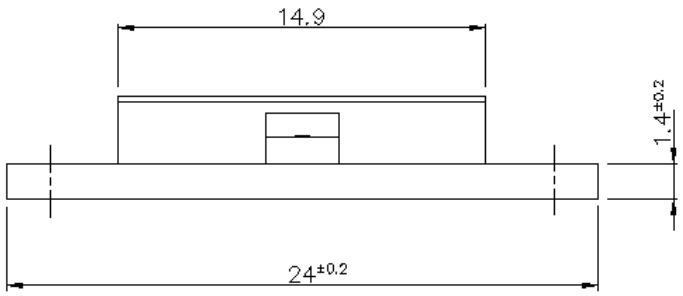
MTTF vs. Tch



Package Outline

Case Style : IK





1. Gate
2. Source
3. Drain
4. Source

Unit: mm

Tolerance: ±0.15

For Safety, Observe the Following Procedures Environmental Management

- Do not put this product into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Respect all applicable laws of the country when discarding this product.
  This product must be disposed in accordance with methods specified by applicable hazardous waste procedures.

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